



#### Features

- Voltage Controlled Small Signal Switch
- N-MOSFET with ESD Gate Protection
- Ideally Suited for Automated Assembly Processes
- Lead Free By Design/ROHS Compliant (Note 1)
- "Green" Device (Note 2)

#### 400mA LOAD SWITCH FEATURING PRE-BIASED PNP TRANSISTOR AND ESD PROTECTED N-MOSFET

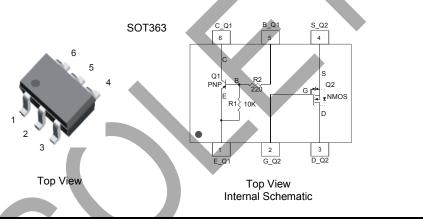
#### **Mechanical Data**

- Case: SOT363
- Case Material: Molded Plastic. "Green Molding" Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin annealed over Alloy 42 leadframe. Solderable per MIL- STD -202, Method 208
- Marking Information: See Page 8
- Ordering Information: See Page 8
- Weight: 0.006 grams (approximate)

### Description

LMN400E01 is best suited for applications where the load needs to be turned on and off using control circuits like micro-controllers, comparators etc. particularly at a point of load. It features a discrete pass transistor with stable  $V_{\mathsf{CE}(\mathsf{SAT})}$  which does not depend on input voltage and can support continuous maximum current of 400 mA. It also contains an ESD protected discrete N-MOSFET that can be used as control. The component can be used as a part of a circuit or as a stand alone discrete device.

		R1(NOM)	R2(NOM)	Figure
Q1 .	PNP Transistor	10K	220	2
Q2 N	I-MOSFET	—		2



#### Ordering Information (Note 3)

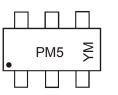
Device	Packaging	Shipping
LMN400E01-7	SOT363	3000/Tape & Reel

Notes:

No purposefully added lead.
 Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.

3. For packaging details, go to our website at http://www.diodes.com.

## Marking Information



PM5 = Product Type Marking Code, YM = Date Code Marking Y = Year, e.g., Y = 2011 M = Month, e.g., 9 = September

Date Code Key												
Year	2006	;	2007	2008		2009	2010		2011	2012		2013
Code	Т		U	V		W	Х		Y	Z		А
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Unit

V

#### Maximum Ratings, Total Device @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit
Power Dissipation	(Note 4)	PD	200	mW
Power Derating Factor above 37.5°C		P <sub>der</sub>	1.6	mW/°C
Output Current		l <sub>out</sub>	400	mA

# Thermal Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Operating and Storage Temperature Range	T <sub>j</sub> , T <sub>STG</sub>	-55 to +150	°C
Thermal Resistance, Junction to Ambient Air (Note 4)	$R_{ ext{ heta}JA}$	625	°C/W

# Maximum Ratings:

Pre-Biased PNP Transistor (Q1) @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	-50	V
Collector-Emitter Voltage	V <sub>CEO</sub>	-50	V
Supply Voltage	V <sub>cc</sub>	-50	V
Input Voltage	V <sub>in</sub>	-6 to +5	V
Output Current	lc	-400	mA

#### Maximum Ratings: ESD Protected N-Channel MOSFET (Q2) @TA

 Characteristic
 Symbol
 Value

 Drain-Source Voltage
 VDSS
 60

Drain Gate Voltage ( $R_{GS} \le 1M$	1 Ohm)	V <sub>DGR</sub>	60	V
Gate-Source Voltage	Continuous	Mara	+/-20	V
	Pulsed (tp<50 uS)	V <sub>GSS</sub>	+/-40	v
Drain Current (Note 4)	Continuous (V <sub>gs</sub> = 10V)		300	mA
. ,	Pulsed (tp <10 uS, Duty Cycle <1%)	ID	800	IIIA
Continuous Source Current		ls	300	mA

Notes: 4. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.



Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 5)			• • •	•		·
Collector-Base Cut Off Current	I <sub>CBO</sub>		_	-500	nA	$V_{CB} = -50V, I_E = 0$
Collector-Emitter Cut Off Current	I <sub>CEO</sub>			-1	uA	$V_{CE} = -50V, I_{B} = 0$
Collector-Base Breakdown Voltage	V <sub>(BR)CBO</sub>	-50			V	$I_{\rm C} = -10 {\rm uA}, I_{\rm E} = 0$
Collector-Emitter Breakdown Voltage	V <sub>(BR)CEO</sub>	-50			V	I <sub>C</sub> = -2mA, I <sub>B</sub> = 0
Input Off Voltage	V <sub>I(OFF)</sub>	-0.3	-0.55		V	V <sub>CE</sub> = -5V, I <sub>C</sub> = -100uA
Ouput Current	I <sub>O(OFF)</sub>	_	_	-1	uA	$V_{CC} = -50V, V_{I} = 0V$
ON CHARACTERISTICS (Note 5)			•			
				-0.15	V	I <sub>C</sub> = -10mA, I <sub>B</sub> = -0.3mA
Collector-Emitter Saturation Voltage	N/		_	-0.3	V	$I_{IC} = -200 \text{mA}, I_{B} = -20 \text{mA}$
	V <sub>CE(SAT)</sub>	_		-0.5	V	I <sub>C</sub> = -400mA, I <sub>B</sub> = -40mA
		_	—	-0.6	V	I <sub>C</sub> = -500mA, I <sub>B</sub> = -50mA
DC Current Gain	h	55	220	_	_	V <sub>CE</sub> = -5V, I <sub>C</sub> = -50mA
	h <sub>FE</sub>	55	225	_		$V_{CE} = -5V, I_C = -400 \text{mA}$
Input On Voltage	VI(ON)	-3	-1.5		V	$V_0 = -0.3V$ , $I_c = -20mA$
Output Voltage (Equivalent to V <sub>CE(SAT)</sub> )	V <sub>O(ON)</sub>		-0.1	-0.3	V	I <sub>o</sub> /I <sub>I</sub> = -50mA /-2.5mA
Input Current	h	_	-18	-45	mA	V1 = -5V
Base-Emitter Turn-on Voltage	V <sub>BE(ON)</sub>		-1.2	-1.6	V	V <sub>CE</sub> = -5V, I <sub>C</sub> = -400mA
Base-Emitter Saturation Voltage	V <sub>BE(SAT)</sub>		-1.9	-2.5	V	I <sub>C</sub> = -50mA, I <sub>B</sub> = -5mA
Input Resistor (Base), +/- 30%	R2	0.154	0.22	0.286	KΩ	
Pull-up Resistor (Base to Vcc supply), +/- 30%	R1	7	10	13	KΩ	
Resistor Ratio (Input Resistor/Pullup resistor)	R1/R2	36	45	55		
SMALL SIGNAL CHARACTERISTICS						
Gain Bandwidth Product	f⊤	_	200		MHz	V <sub>CE</sub> = -10V, I <sub>E</sub> = -5mA, f = 100MHz

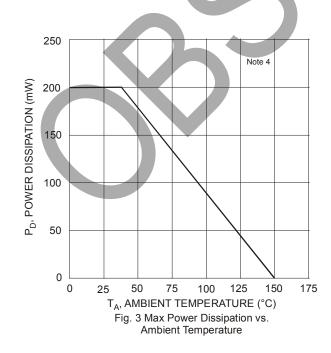
Notes: 5. Short duration pulse test used to minimize self-heating effect.

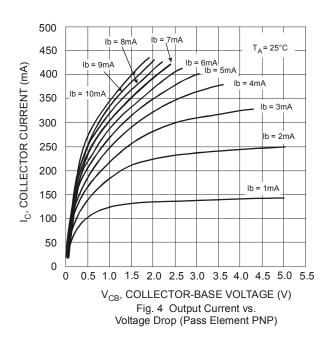


### Electrical Characteristics: ESD Protected N-Channel MOSFET (Q2) @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Мах	Unit	Test Condition
OFF CHARACTERISTICS (Note 5)					•	·
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	60	_		V	V <sub>GS</sub> = 0V, I <sub>D</sub> = 10uA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1	μA	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 60V
Gate-Body Leakage Current, Forward	I <sub>GSSF</sub>	_	_	10	μA	$V_{GS} = 20V, V_{DS} = 0V$
Gate-Body Leakage Current, Reverse	I <sub>GSSR</sub>	_	_	-10	μA	$V_{GS}$ = -20V, $V_{DS}$ = 0V
ON CHARACTERISTICS (Note 5)						
Gate Source Threshold Voltage	V <sub>GS(th)</sub>	1	1.6	2.5	V	$V_{DS} = V_{GS}, I_D = 0.25 mA$
Statia Drain Source On State Voltage	V	_	0.09	1.9	v	$V_{GS}$ = 5V, $I_D$ = 50mA
Static Drain-Source On-State Voltage	V <sub>DS(on)</sub>		0.6	3.75	V I	V <sub>GS</sub> = 10V, I <sub>D</sub> = 500mA
On-State Drain Current	I <sub>D(on)</sub>	500	_		mA	V <sub>GS</sub> = 10V, V <sub>DS</sub> ≥2*V <sub>DS</sub> (ON)
Static Drain-Source On Resistance	6		1.6	3	Ω	$V_{GS}$ = 5V, $I_D$ = 50mA
Static Drain-Source On Resistance	R <sub>DS(on)</sub>		1.2	2	52	V <sub>GS</sub> = 10V, I <sub>D</sub> = 500mA
Forward Transconductance	<b>g</b> fs	80	260		mS	V <sub>DS</sub> ≥2*V <sub>DS(ON)</sub> , I <sub>D</sub> = 200 mA
DYNAMIC CHARACTERISTICS						
Input Capacitance	C <sub>iss</sub>			50	pF	
Output Capacitance	Coss	_	—	25	pF	V <sub>DS</sub> = -25V, V <sub>GS</sub> = 0V, f = 1MHz
Reverse Transfer Capacitance	Crss	—	_	5	pF	
SWITCHING CHARACTERISTICS (Note 5)						
Turn-On Delay Time	td <sub>(on)</sub>		_	20	ns	V <sub>DD</sub> = 30V, V <sub>GS</sub> =10V,
Turn-Off Delay Time	td <sub>(off)</sub>	-	—	40	ns	$I_D$ = 200mA, R <sub>G</sub> = 25 Ohm, R <sub>L</sub> = 150 Ohm
SOURCE-DRAIN (BODY) DIODE CHARACTERISTICS	ND MAXIM	UM RATIN	GS			
Drain-Source Diode Forward On-Voltage	V <sub>SD</sub>	—	0.88	1.5	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 300 mA*
Maximum Continuous Drain-Source Diode Forward Current (Reverse Drain Current)	۱ <sub>S</sub>	-	_	300	mA	
Maximum Pulsed Drain-Source Diode Forward Current	Ism	-	_	800	mA	

Notes: 5. Short duration pulse test used to minimize self-heating effect.

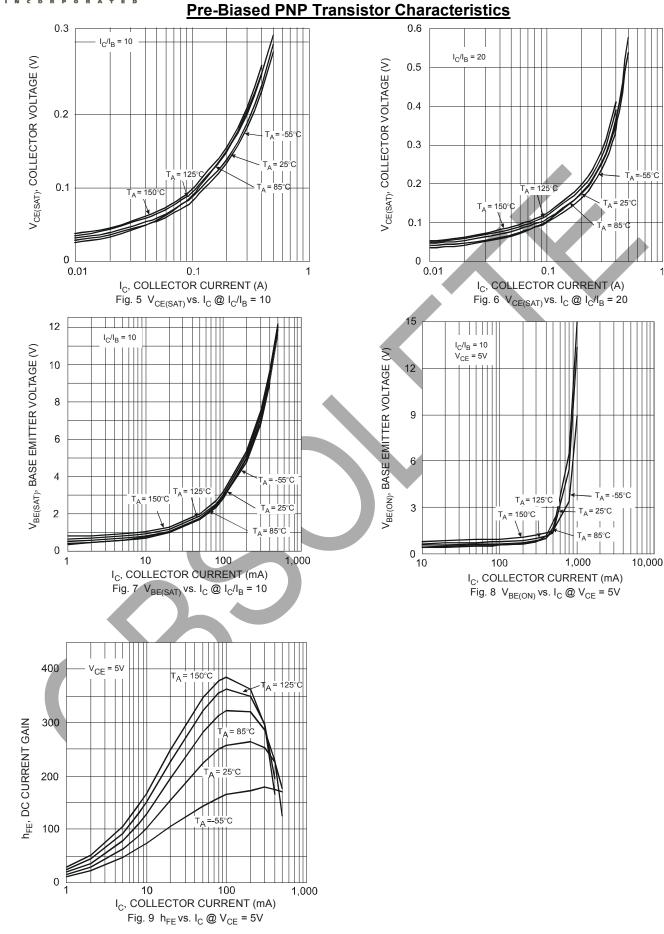






#### LMN400E01

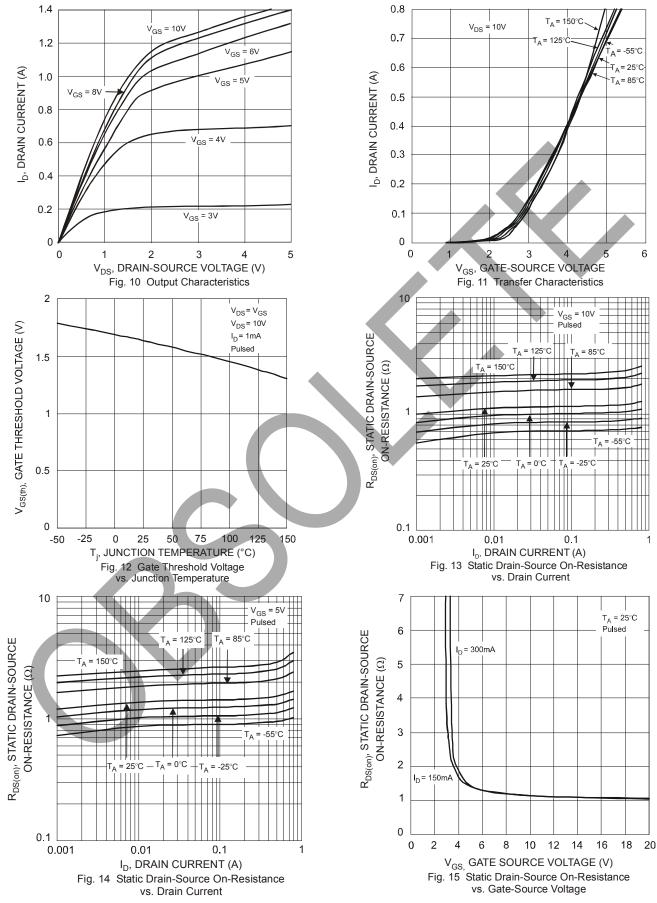
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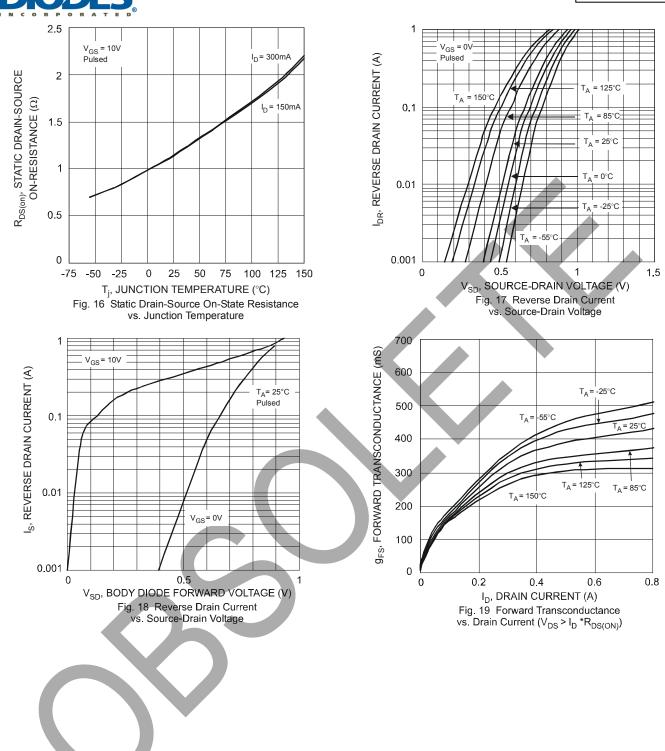


#### LMN400E01











#### Application Details

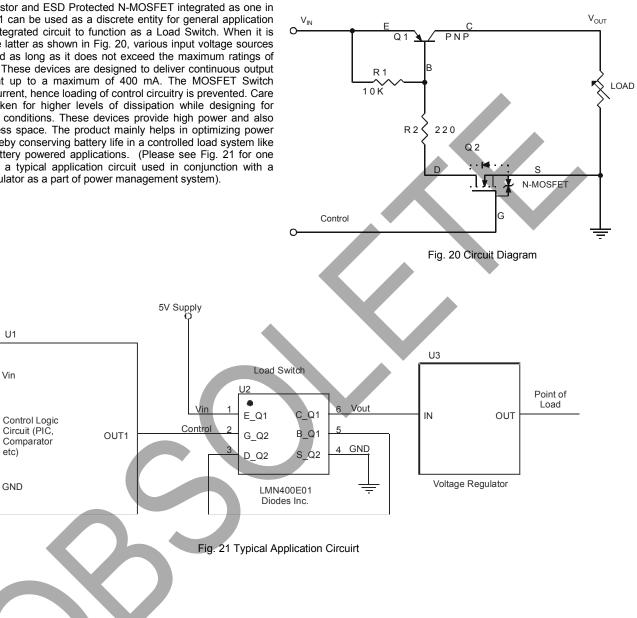
U1

Vin

etc)

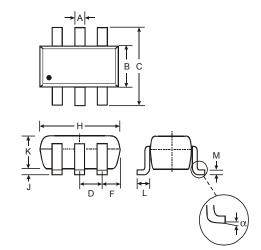
GND

PNP Transistor and ESD Protected N-MOSFET integrated as one in LMN400E01 can be used as a discrete entity for general application or as an integrated circuit to function as a Load Switch. When it is used as the latter as shown in Fig. 20, various input voltage sources can be used as long as it does not exceed the maximum ratings of the device. These devices are designed to deliver continuous output load current up to a maximum of 400 mA. The MOSFET Switch draws no current, hence loading of control circuitry is prevented. Care must be taken for higher levels of dissipation while designing for higher load conditions. These devices provide high power and also consume less space. The product mainly helps in optimizing power usage, thereby conserving battery life in a controlled load system like portable battery powered applications. (Please see Fig. 21 for one example of a typical application circuit used in conjunction with a voltage regulator as a part of power management system).



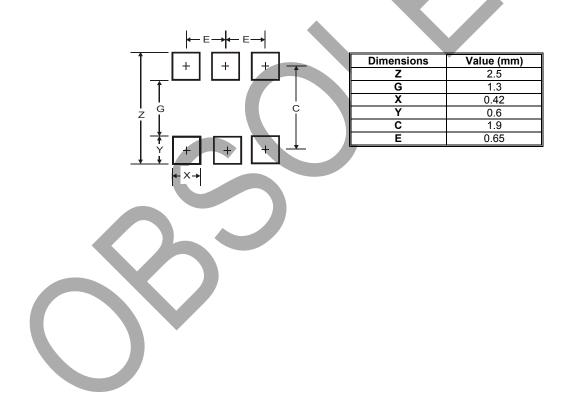


### **Package Outline Dimensions**



Min 0.10 1.15	<b>Max</b> 0.30	
	0.30	
1.15		
-	1.35	
2.00	2.20	
0.65 N	ominal	
0.30	0.40	
1.80	2.20	
-	0.10	
0.90	1.00	
0.25	0.40	
0.10	0.25	
0°	8°	
mensions i	n mm	
r	0.65 N 0.30 1.80 - 0.90 0.25 0.10 0°	0.65 Nominal           0.30         0.40           1.80         2.20           -         0.10           0.90         1.00           0.25         0.40           0.10         0.25

## Suggested Pad Layout





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